

**MIP0221SY, MIP0222SY, MIP0223SY, MIP0224SY, MIP0225SY, MIP0226SY, MIP0227SY****Silicon MOS IC****■ Features**

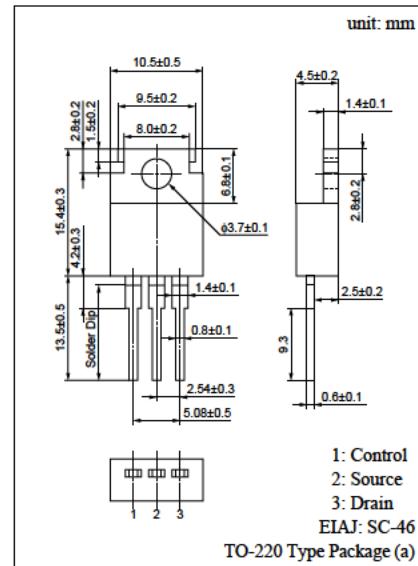
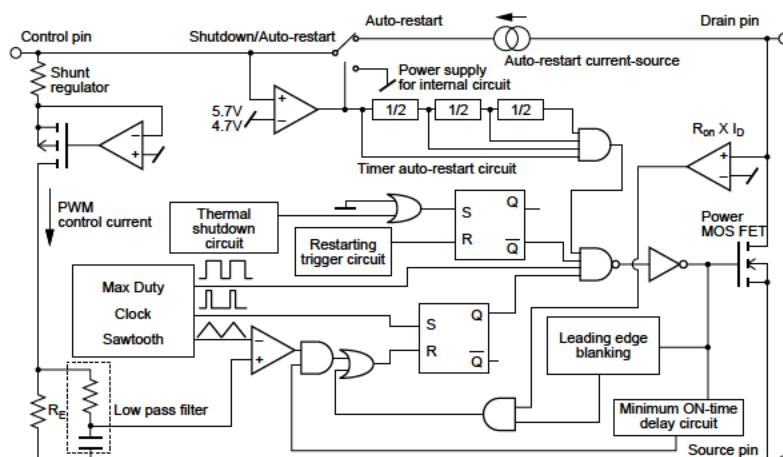
- Single chip IC with high breakdown voltage power MOS FET and CMOS control circuits
- Allowing to input worldwide mains (AC 85 to 274V)
- A pulse-by-pulse overcurrent protection circuit and a timer auto-restart circuit are integrated.

**■ Applications**

- Switching power supply (to 90W)
- AC adaptor
- Battery charger

**■ Absolute Maximum Ratings (Ta = 25 ± 3°C)**

Parameter	Symbol	Ratings	Unit
Drain voltage	V <sub>D</sub>	700	V
Control voltage	V <sub>C</sub>	8	V
Output current	I <sub>D</sub>	MIP0221SY 0.3	A
		MIP0222SY 0.585	
		MIP0223SY 1.15	
		MIP0224SY 1.72	
		MIP0225SY 2.4	
		MIP0226SY 2.9	
		MIP0227SY 3.5	
Control current	I <sub>C</sub>	0.1	mA
Channel temperature	T <sub>ch</sub>	150	C
Storage temperature	T <sub>stg</sub>	-55 to +150	C

**■ Block Diagram**

■ Electrical Characteristics ( $T_C = 25 \pm 2^\circ\text{C}$ )

	Parameter	Symbol	Conditions	min	typ	max	Unit	
Control functions	Output frequency	f <sub>OSC</sub>	I <sub>C</sub> = 2mA	90	100	110	kHz	
	Maximum duty cycle	MAXDC	I <sub>C</sub> = 2mA	64	67	70	%	
	Minimum duty cycle	MINDC	I <sub>C</sub> = 10mA			3	%	
Auto-restart	Control pin charging current	I <sub>C</sub>	V <sub>C</sub> = 0	-2.4	-1.9	-1.2	mA	
			V <sub>C</sub> = 5V	-2	-1.5	-0.8		
	Auto-restart threshold voltage	V <sub>C(on)</sub>		5	5.7	6.3	V	
	Lockout threshold voltage	V <sub>C(off)</sub>		4	4.7	5.3	V	
	Auto-restart hysteresis voltage	ΔV <sub>C</sub>		0.5	1	1.5	V	
	Auto-restart duty cycle	T <sub>SW/TIM</sub>			5	8	%	
Circuit protection	Auto-restart frequency	f <sub>TIM</sub>			1.2		Hz	
	MIP0221SY	I <sub>LIMIT</sub>		0.23	0.25	0.28	A	
	MIP0222SY			0.45	0.5	0.55		
	MIP0223SY			0.9	1	1.1		
	MIP0224SY			1.35	1.5	1.65		
	MIP0225SY			1.8	2	2.2		
	MIP0226SY			2.25	2.5	2.75		
	MIP0227SY			2.7	3	3.3		
	Leading edge blanking delay	t <sub>on(BLK)</sub>	I <sub>C</sub> = 3mA		0.25		μs	
	Current limit delay	t <sub>d(OCL)</sub>	I <sub>C</sub> = 3mA		0.1		μs	
	Thermal shutdown temperature	T <sub>OTP</sub>	I <sub>C</sub> = 3mA	130	140	150	C	
	Power-up reset threshold voltage	V <sub>C reset</sub>		2.3	3.3	4.2	V	
Output	ON-state resistance	MIP0221SY	R <sub>DS(on)</sub>	I <sub>D</sub> = 0.025A		31.2	36	Ω
		MIP0222SY		I <sub>D</sub> = 0.1A		15	18	
		MIP0223SY		I <sub>D</sub> = 0.2A		8.5	10	
		MIP0224SY		I <sub>D</sub> = 0.3A		5.8	6.7	
		MIP0225SY		I <sub>D</sub> = 0.3A		4	5	
		MIP0226SY		I <sub>D</sub> = 0.3A		3.3	4	
		MIP0227SY		I <sub>D</sub> = 0.3A		2.6	3	
	OFF-state current	I <sub>DSS</sub>	V <sub>DS</sub> = 650V, Output MOS FET disabled		0.01	0.25	mA	
	Breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> = 0.25mA, Output MOS FET disabled	700			V	
	Rise time	t <sub>r</sub>			0.1	0.2	μs	
	Fall time	t <sub>f</sub>			0.1	0.2	μs	
Power supply voltage	Drain supply voltage	V <sub>D(MIN)</sub>			36		V	
	Shunt regulator voltage	V <sub>C</sub>	I <sub>C</sub> = 3mA		5.4	5.7	6.1	V
	Control supply/discharge current	I <sub>CD1</sub>	Output MOS FET enabled		0.7	1.4	1.8	mA
		I <sub>CD2</sub>	Output MOS FET disabled		0.5	0.8	1.1	mA